

## GX66473

4 x 64Gbps Linear Differential Driver

The GX66473 is a very low-power, high-performance, quad-channel linear driver, designed for 200G/400G optical transmitters for metro applications.

The GX66473 is a small form factor (SFF) packaged surface mount device (SMD) with differential inputs and single-ended outputs consisting of 4 x 64Gbps broadband amplifier channels, each capable of driving a linear output voltage of 4.5Vpp, suitable for multi-level modulation applications.

## Features

- Data rate up to 64Gbps per channel for 200G/400G DP-mQAM applications
- > 10dB dynamic range of gain control
- 1.1 W (typical) per channel at linear 4.5 V<sub>pp</sub>
- Ultra-low inter-channel cross-talk
- Small form factor SMD
- Internal high-frequency chokes to supplies
- Internally DC-blocked RF inputs and outputs
- Peak detector and reference voltage

## Applications

- 200Gbps and 400Gbps advanced multi-level modulation systems
- High bandwidth CFP2-ACO form factor

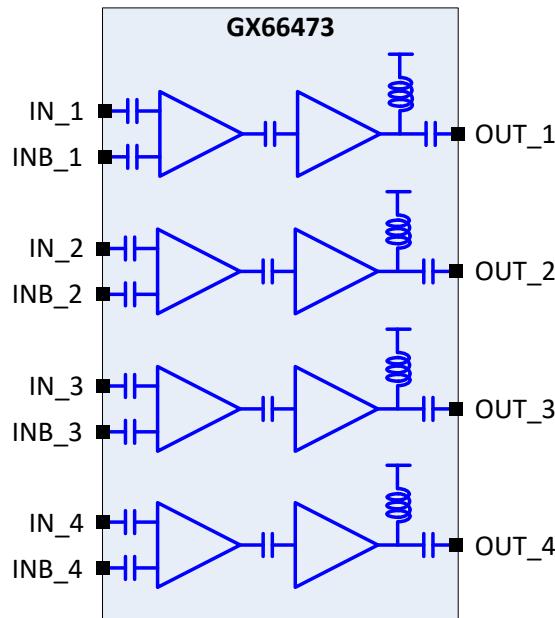


Figure 1. Block Diagram

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